

September 2014

# FSA8028 Audio Jack Detection and Configuration Switch

#### **Features**

	Accessory Plug-In
Detection	3- or 4-Pole Audio Jack
	Send/End Key Pressed
Functionality	Decreased Timing for Sensitive
	Send/End Keys
Switch Type	MIC
$V_{DD}$	2.5 to 4.4 V
$V_{IO}$	1.6 to V <sub>DD</sub>
THD (MIC)	0.01% Typical
ESD (Air Gap)	15 kV
Operating Temperature	-40°C to 85°C

# Description

The FSA8028 is an audio jack detector and switch for 3- or 4-pole accessories. In addition to detection, the FSA8028 features an integrated MIC switch that allows the processor to configure the audio jack. The architecture is designed to allow common third-party headphones to be used for listening to music from mobile handsets, personal media players, and portable peripheral devices.

- Determines 3- or 4-Pole Audio Jacks
- Removes Audio Jack Pop-n-Click Caused by MIC Bias
- Detects Audio Jack Accessories:
  - Standard Headphones
  - Headsets with MIC
  - Send / End Button Presses
- Integrates a MIC Switch for 4-Pole Configuration

# **Applications**

- 3.5 mm and 2.5 mm Audio Jacks
- Cellular Phones, Smart Phones
- MP3 and PMP

# **Ordering Information**

Part Number	Operating Temperature Range	Top Mark	Package
FSA8028UMX	-40 to +85°C	KZ	10-Lead, 1.4 x 1.8 x 0.55 mm, 0.4 mm Pitch, Ultrathin Molded Leadless Package (UMLP)

# **Typical Application**

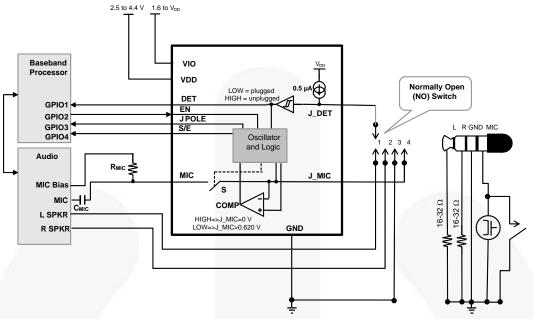


Figure 1. Mobile Phone Example

# **Pin Configuration**

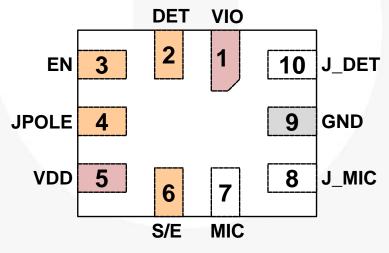


Figure 2. 10-Lead UMLP Pin Assignment (Through View)

# **Pin Descriptions**

Name	Pin#	Туре	Description		Function		
DET	2	Output	Indicates if an accessory is plugged into the audio jack, as		Plugged		
DET	2	Output	detected on the J_DET pin	1	Unplugged		
JPOLE	4	Output	Indicates if an accessory plugged into the audio jack is 3 pole	0	4-pole jack		
JFOLL	4	Output	or 4 pole	1	3-pole jack		
S/E	6	Output	Indicates state of SEND/END for a 4-pole accessory when a	0	No key press		
3/E	b	Output	key has been pressed	1	Key press		
EN	3	Input	Controls internal microphone switch between the J_MIC and		MIC / J_MIC switch open		
LIN	3	input	MIC pins	1	MIC / J_MIC switch closed		
		1	Input from a pin of the audio jack socket tied to a mechanical	0	Plugged		
J_DET	10	Input	switch that typically closes whenever an audio jack is inserted into that socket	1	Unplugged		
MIC	7	Switch	Microphone switch path that goes to the microphone preamplifier	Soci	EN pin		
J_MIC	8	Switch	Microphone switch path that connects to the microphone and SEND/END key audio jack pole	366 1	_ιν ριπ		
VDD	5	Power	Core supply voltage				
VIO	1	Power	Baseband I/O supply voltage				
GND	9	Ground	Ground for both the audio jack and the PCB				

Note:  $1.0 = V_{OL}$  or  $V_{IL}$ ;  $1 = V_{OH}$  or  $V_{IH}$ 

# **Functional Diagram**

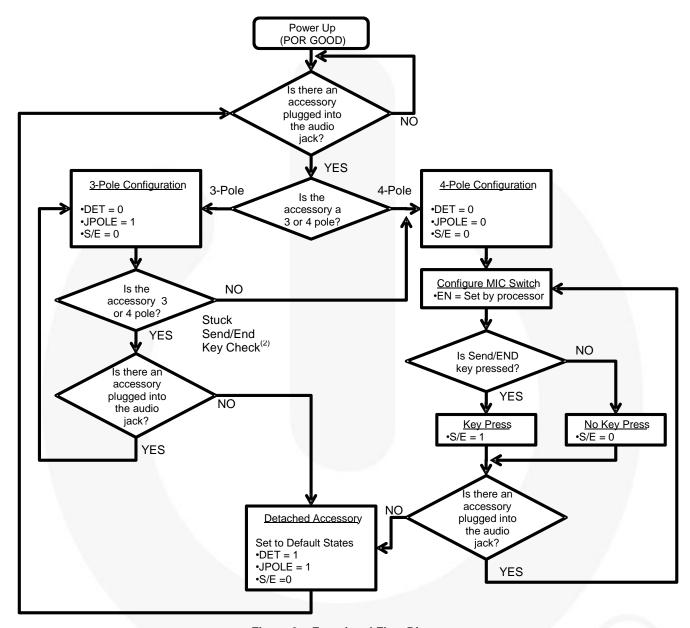


Figure 3. Functional Flow Diagram

#### Note:

2. Stuck Send/End key function is only available if EN=HIGH.

Table 1. FSA8028 Stuck Send/End Key

EN	FSA8028
HIGH	Stuck Send / End Key Active
LOW	Stuck Send / End Key Disabled

Table 2. States During Power Good and OFF

State Description	VDD	VIO	DET	EN	JPOLE	S/E	J-DET	MIC Switch
Active	1	1	Active					
	0	0				_		
OFF	1	0	1 (unplugged) 3-State		(3 Pole)	(No Press)	HIGH (unplugged)	Open
	0	1	(anplaggoa)		(0.00)	(1.10.1.1000)	(G.Ipiaggoa)	

Table 3. FSA8028 I/O States During Detection<sup>(3)</sup>

I DET	L DET L MIC		S	/E	JPC	DET		
J_DET   J_N	J_MIC	J_WIIC	EN	3 Pole	4 Pole	3 Pole	4 Pole	DEI
0	1	1	0 (no press)	0 (no press)	0 (4 Pole)	0 (4 Pole)	0	
0	0	0	0 (no press)	1 (press)	1 (3 Pole)	0 (4 Pole)	0	
0	1	0	0 (no press)	0 (no press)	1 (3 Pole)	0 (4 Pole)	0	
0	0	1	0 (no press)	1 (press)	1 (3 Pole)	0 (4 Pole)	0	
1	X	Х	0 (no press)	0 (no press)	1 (3 Pole)	1 (3 Pole)	1	

#### Note:

3. State detected after initial plug-in.

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Units
V <sub>DD</sub> & V <sub>IO</sub>	Supply Voltage from Battery		-0.5	6.0	V
V <sub>SW</sub>	Switch I/O Voltage for "S" Switch and All Input V	oltages Except J_DET	-0.5	V <sub>DD</sub> +0.5	V
V <sub>JD</sub>	Input Voltage for J_DET Input		-1.5	V <sub>DD</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Diode Current		-50		mA
I <sub>SW</sub>	Switch I/O Current (Continuous)			50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Maximum Junction Temperature			+150	°C
TL	Lead Temperature (Soldering, 10 Seconds)			+260	°C
1/1	IEC 61000-4-2 System ESD	Air Gap	15.0		
		Contact	8.0		]
ESD	IEDEC IESD22 A114 Human Pody Model	All Pins	7.5		kV
	JEDEC JESD22-A114, Human Body Model	J_DET, J_MIC, V <sub>DD</sub> , V <sub>IO</sub>	12.0		
	JEDEC JESD22-C101, Charged Device Model	2.0			

#### Note:

4. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Units
$V_{DD}$	Battery Supply Voltage	2.5	4.4	٧
V <sub>IO</sub>	Parallel I/O Supply Voltage	1.6	$V_{DD}$	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C

# **DC Electrical Characteristics**

All typical values are at T<sub>A</sub>=25°C unless otherwise specified.

Symbol	Parameter	V <sub>DD</sub> (V)	Conditions	T <sub>A</sub> =	Units		
Symbol			Conditions	Min.	Тур.	Max.	Units
MIC Switch	1					•	
		2.5	9.		0.9	2.9	
Ron	MIC Switch On Resistance	2.8	$I_{OUT} = 30 \text{ mA},$ $V_{IN} = 2.0 \text{ V}$		0.8	2.5	
		3.8	VIN - 2.0 V		0.6	2.0	
		2.5	I <sub>OUT</sub> = 30 mA, V <sub>IN</sub> = 1.6, 2.0, 2.5 V		1.50		Ω
$R_{FLAT(ON)}$	On Resistance Flatness	2.8	I <sub>OUT</sub> = 30 mA,	/	0.70		
		3.8	$V_{IN} = 1.6, 2.0, 2.8 \text{ V}$	A1	0.25		
V <sub>IN</sub>	Switch Input Voltage Range	2.5 to 4.4		0		$V_{DD}$	V
C <sub>ON</sub>	MIC and J_MIC Switch ON Capacitance	3.8	f = 1 MHz		76		pF
$C_{OFF}$	MIC and J_MIC Switch OFF Capacitance	3.8	f = 1 MHz		24		pF
J_DET				1		2	
J_DET <sub>AudioV</sub>	Audio Voltage Range on J_DET Pin	2.5 to 4.4	DET = LOW	-1		1	V
J_DET <sub>Audiof</sub>	Audio Frequency on J_DET Pin	2.5 to 4.4	DET = LOW	20		20000	Hz
J_DET <sub>RGND</sub>	Detection Resistance to Ground	2.5 to 4.4	Audio Jack Inserted	0		500	ΚΩ
J_DET <sub>HYS</sub>	Hysteresis of J_DET				230		mV
Parallel I/O							
V <sub>IH</sub>	Input High Voltage	Veri.		0.7 x V <sub>IO</sub>		V <sub>IO</sub>	V
$V_{IL}$	Input Low Voltage					0.3 x V <sub>IO</sub>	V
V <sub>OH</sub>	Output High Voltage		I <sub>OH</sub> = -100 μA	0.8 x V <sub>IO</sub>			V
V <sub>OL</sub>	Output Low Voltage		I <sub>OL</sub> = +100 μA			0.2 x V <sub>IO</sub>	V
Comparato	or						
$V_{COMP}$	Comparator Threshold for SEND/END Sensing	2.5-3.8	J_DET, EN = LOW		620		mV
Current		~ .					
l <sub>OFF</sub>	Power Off Leakage Current Through Switch	0	MIC and J_MIC Ports V <sub>IN</sub> = 4.4 V			1.5	μA
I <sub>IN</sub>	Input Leakage Current	0 to 4.4	Inputs 0 = 4.4 V			1	μA
I <sub>CC-SLNA</sub>	Battery Supply Sleep Mode Current No Accessory Attached	2.5 to 4.4	Static Current During Sleep Mode (EN = LOW)		1	3	μA
I <sub>CC-SLWA</sub>	Battery Supply Sleep Mode Current with Accessory Attached	2.5 to 4.4	Active Current (EN = LOW and/or DET = HIGH)		15	25	μA

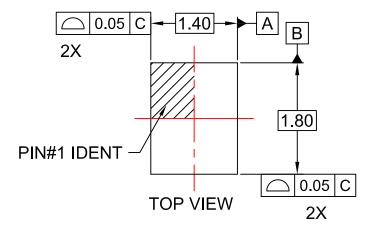
# **AC Electrical Characteristics**

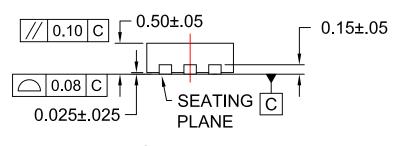
All typical values are for  $V_{CC}$ =3.3 V at  $T_A$ =25°C unless otherwise specified.

Cumbal	Parameter	V <sub>DD</sub> (V)	Conditions	$T_A = -40 \text{ to } +85^{\circ}\text{C}$			11
Symbol				Min.	Тур.	Max.	Unit
MIC Swite	ch						•
THD	Total Harmonic Distortion	3.8	$R_T = 600 \ \Omega, \ V_{SW} = 0.5 \ V_{PP}, \ f = 20 \ Hz \ to \ 20 \ kHz, \ V_{IN} = 2.0 \ V$		0.01		%
O <sub>IRR</sub>	Off Isolation	3.8	$\begin{split} &\text{f} = 20 \text{ kHz},  \text{R}_\text{S} \! = \! 32  \Omega, \\ &\text{C}_\text{L} \! = \! 0 \text{ pF},  \text{R}_\text{T} \! = \! 32  \Omega \end{split}$		-90		dB
Parallel I/	O						
	Output Edge Detec (DET C/E IDOLE)	2.5	C 5 7 5 200/ to 000/		19		
$t_R$ , $t_F$	Output Edge Rates (DET, S/E, JPOLE)	3.8	$C_L = 5 \text{ pF}, 20\% \text{ to } 80\%$		15		ns
t <sub>POLL</sub>	On Time of MIC Switch for Sensing SEND/END Button Press Oscillator Stable Time	2.5 to 4.4			1		ms
t <sub>PER</sub>	Period of MIC Switching Time for Sensing SEND/END Button Press	2.5 to 4.4			10		ms
t <sub>DET-IN</sub>	Debounce Time after J-DET Changes State from High to Low	2.5 to 4.4		1	422		ms
t <sub>DET_REM</sub>	Debounce Time after J_DET Changes State from Low to High	2.5 to 4.4		\	30		μs
t <sub>DET</sub>	Detection Timeout for Sensing 3-Pole or 4-Pole Audio Jack Plugged In	2.5 to 4.4			4.5		ms
t <sub>KBK</sub>	Debounce Time for Sensing SEND/END Key Press / Release	2.5 to 4.4			27		ms
Power		V.	y.			LI.	
PSRR	Power Supply Rejection Ratio	3.8	Power Supply Noise 300 mV <sub>PP</sub> , Measured 10/90%, f = 217 Hz	A	-90	1	dB

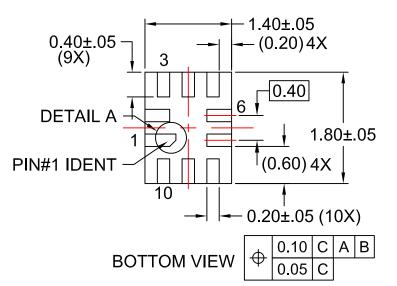
Table 4. Package Nominal Values

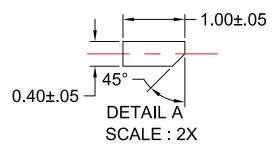
JEDEC Symbol	Description	Nominal Values (mm)
A	Overall Height	0.5
A1	Package Standoff	0.072
A3	Lead Thickness	0.152
b	Lead Width	0.4
L	Lead Length	0.2
e	Lead Pitch	0.4
D	Body Length (Y)	1.8
Е	Body Width (X)	1.4

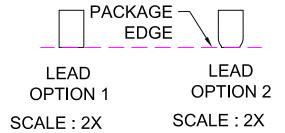


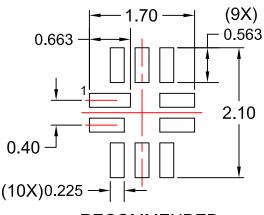


SIDE VIEW

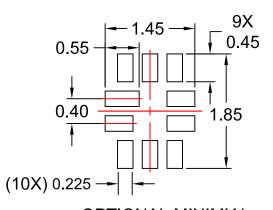








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